IGBT

High speed IGBT in Trench and Fieldstop technology
recommended in combination with SiC Diode IDH15S120

IGW25N120H3

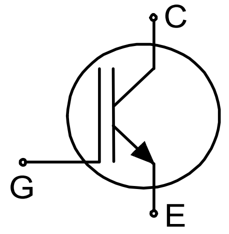
1200V high speed switching series third generation

Data sheet

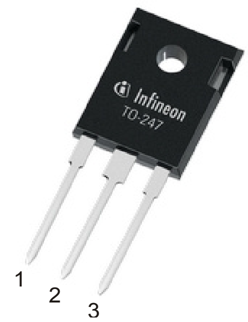
Industrial Power Control

High speed IGBT in Trench and Fieldstop technology recommended in combination with SiC Diode IDH15S120

Features:



TRENCHSTOP™ technology offering
• best in class switching performance: less than 500µJ total switching losses achievable
• very low V_{CEsat}
• low EMI
• maximum junction temperature 175°C
• qualified according to JEDEC for target applications
• Pb-free lead plating; RoHS compliant
• complete product spectrum and PSpice Models: http://www.infineon.com/igbt/



Applications:

• solar inverters
• uninterruptible power supplies
• welding converters
• converters with high switching frequency

Package pin definition:

• Pin 1 - gate
• Pin 2 & backside - collector
• Pin 3 - emitter

Key Performance and Package Parameters

Type	V_{CE}	I_C	V_{CEsat}, T_{vj}=25°C	T_{vjmax}	Marking	Package
IGW25N120H3	1200V	25A	2.05V	175°C	G25H1203	PG-TO247-3

Table of Contents

Maximum ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CE}	1200	V
DC collector current, limited by T_{vjmax} T_C = 25°C T_C = 100°C	I_C	 50.0 25.0	A
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpuls}	100.0	A
Turn off safe operating area $V_{CE} \leq$ 1200V, $T_{vj} \leq$ 175°C	-	100.0	A
Gate-emitter voltage	V_{GE}	±20	V
Short circuit withstand time V_{GE} = 15.0V, $V_{CC} \leq$ 600V Allowed number of short circuits < 1000 Time between short circuits: ≥ 1.0s T_{vj} = 175°C	t_{SC}	10	µs
Power dissipation T_C = 25°C Power dissipation T_C = 100°C	P_{tot}	326.0 156.0	W
Operating junction temperature	T_{vj}	-40...+175	°C
Storage temperature	T_{stg}	-55...+150	°C
Soldering temperature, wave soldering 1.6 mm (0.063 in.) from case for 10s		260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	M	0.6	Nm

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance, junction - case	$R_{th(j-c)}$		0.46	K/W
Thermal resistance junction - ambient	$R_{th(j-a)}$		40	K/W

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	V_{GE} = 0V, I_C = 0.50mA	1200	-	-	V
Collector-emitter saturation voltage	V_{CEsat}	V_{GE} = 15.0V, I_C = 25.0A T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 175°C	 - - -	 2.05 2.50 2.70	 2.40 - -	V
Gate-emitter threshold voltage	$V_{GE(th)}$	I_C = 0.85mA, V_{CE} = V_{GE}	5.0	5.8	6.5	V
Zero gate voltage collector current	I_{CES}	V_{CE} = 1200V, V_{GE} = 0V T_{vj} = 25°C T_{vj} = 175°C	 - -	 - -	 250.0 2500.0	µA
Gate-emitter leakage current	I_{GES}	V_{CE} = 0V, V_{GE} = 20V	-	-	600	nA
Transconductance	g_{fs}	V_{CE} = 20V, I_C = 25.0A	-	13.0	-	S

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristic						
Input capacitance	C_{ies}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz	-	1430	-	pF
Output capacitance	C_{oes}		-	95	-	
Reverse transfer capacitance	C_{res}		-	75	-	
Gate charge	Q_G	V_{CC} = 960V, I_C = 25.0A, V_{GE} = 15V	-	115.0	-	nC
Short circuit collector current Max. 1000 short circuits Time between short circuits: ≥ 1.0s	$I_{C(SC)}$	V_{GE} = 15.0V, V_{CC} ≤ 600V, t_{SC} ≤ 10µs T_{vj} = 175°C	-	87	-	A

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic, at T_{vj} = 25°C						
Turn-on delay time	$t_{d(on)}$	T_{vj} = 25°C, V_{CC} = 600V, I_C = 25.0A, V_{GE} = 0.0/15.0V, r_G = 23.0Ω, $L\sigma$ = 80nH, $C\sigma$ = 67pF $L\sigma$, $C\sigma$ from Fig. E Energy losses include “tail” and diode (IKW25N120H3) reverse recovery.	-	27	-	ns
Rise time	t_r		-	41	-	ns
Turn-off delay time	$t_{d(off)}$		-	277	-	ns
Fall time	t_f		-	17	-	ns
Turn-on energy	E_{on}		-	1.80	-	mJ
Turn-off energy	E_{off}		-	0.85	-	mJ
Total switching energy	E_{ts}		-	2.65	-	mJ
Turn-on energy	E_{on}	T_{vj} = 25°C, V_{CC} = 800V, I_C = 10.0A, V_{GE} = 0.0/15.0V, r_G = 3.0Ω, $L\sigma$ = 80nH, $C\sigma$ = 67pF $L\sigma$, $C\sigma$ from Fig. E Energy losses include “tail” and diode (IDH15S120) reverse recovery.	-	0.08	-	mJ
Turn-off energy	E_{off}		-	0.27	-	mJ
Total switching energy	E_{ts}		-	0.35	-	mJ

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic, at T_{vj} = 175°C						
Turn-on delay time	$t_{d(on)}$	T_{vj} = 175°C, V_{CC} = 600V, I_C = 25.0A, V_{GE} = 0.0/15.0V, r_G = 23.0Ω, $L\sigma$ = 80nH, $C\sigma$ = 67pF; $L\sigma$, $C\sigma$ from Fig. E; Energy losses include “tail” and diode (IKW25N120H3) reverse recovery.	-	26	-	ns
Rise time	t_r		-	35	-	ns
Turn-off delay time	$t_{d(off)}$		-	347	-	ns
Fall time	t_f		-	50	-	ns
Turn-on energy	E_{on}		-	2.60	-	mJ
Turn-off energy	E_{off}		-	1.70	-	mJ
Total switching energy	E_{ts}		-	4.30	-	mJ
Turn-on energy	E_{on}	T_{vj} = 175°C, V_{CC} = 800V, I_C = 10.0A, V_{GE} = 0.0/15.0V, r_G = 3.0Ω, $L\sigma$ = 80nH, $C\sigma$ = 67pF; $L\sigma$, $C\sigma$ from Fig. E; Energy losses include “tail” and diode (IDH15S120) reverse recovery.	-	0.10	-	mJ
Turn-off energy	E_{off}		-	0.62	-	mJ
Total switching energy	E_{ts}		-	0.72	-	mJ

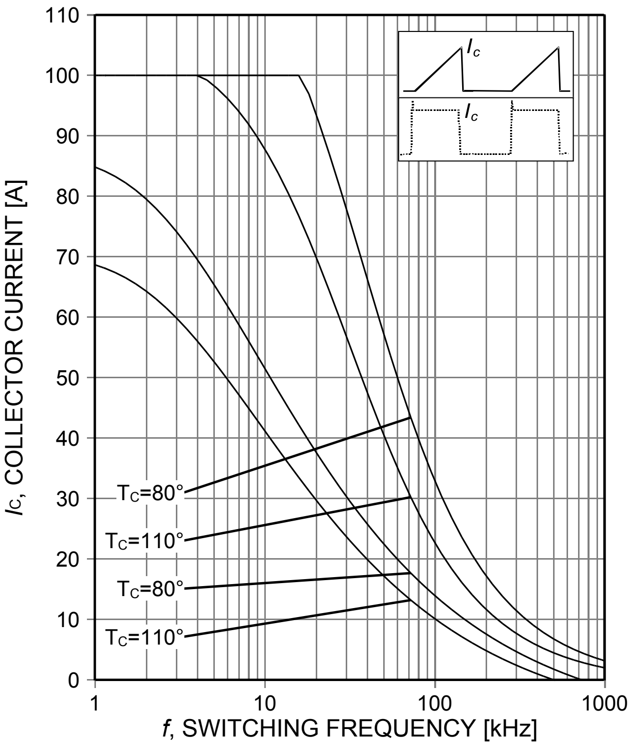


Figure 1. **Collector current as a function of switching frequency**
(T_j≤175°C, D=0.5, V_{CE}=600V, V_{GE}=15/0V, r_G=23Ω)

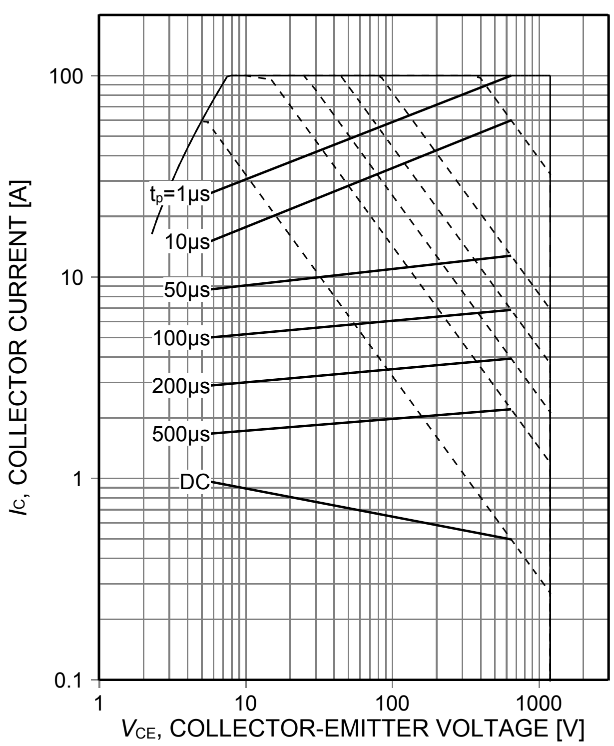


Figure 2. **Forward bias safe operating area**
(D=0, T_C=25°C, T_j≤175°C; V_{GE}=15V)

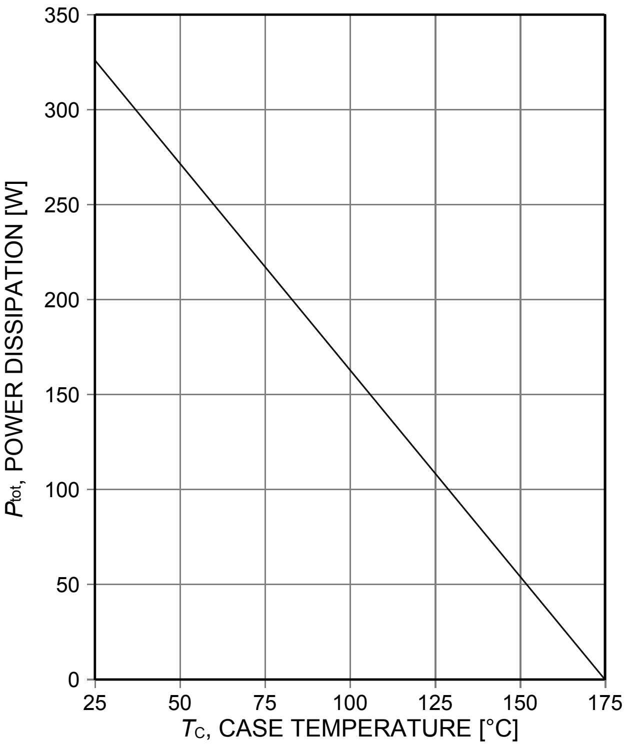


Figure 3. **Power dissipation as a function of case temperature**
(T_j≤175°C)

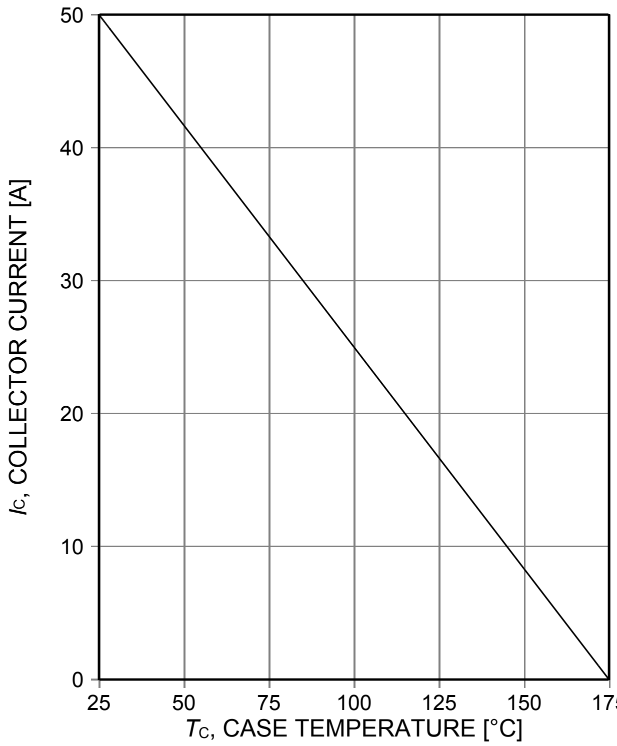


Figure 4. **Collector current as a function of case temperature**
(V_{GE}≥15V, T_j≤175°C)

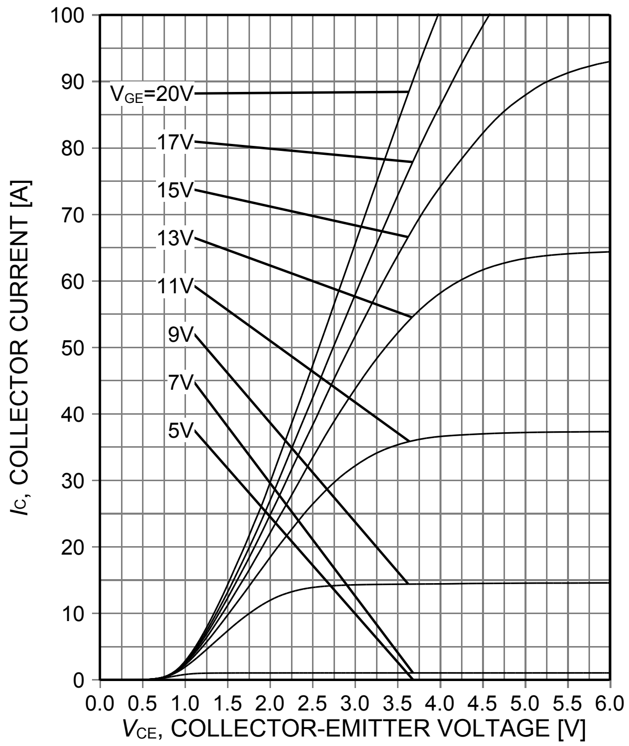


Figure 5. **Typical output characteristic**
(T_j=25°C)

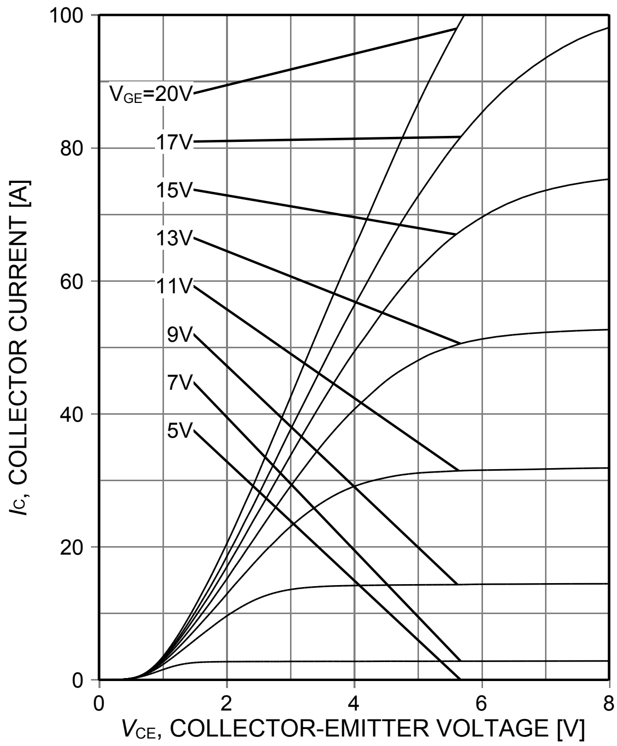


Figure 6. **Typical output characteristic**
(T_j=175°C)

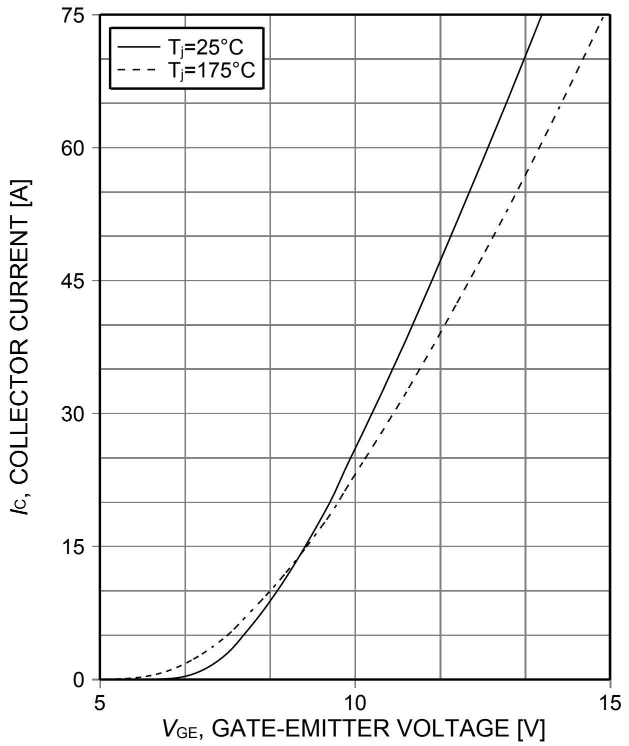


Figure 7. **Typical transfer characteristic**
(V_{CE}=20V)

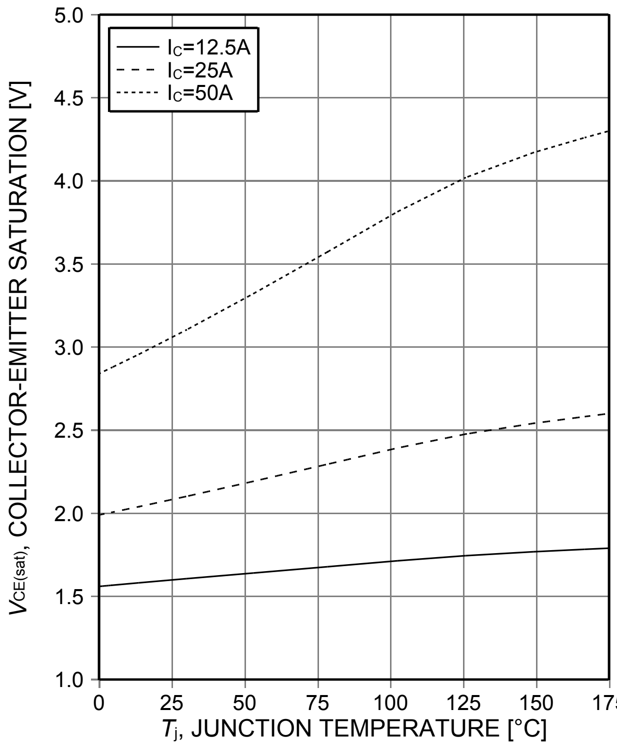


Figure 8. **Typical collector-emitter saturation voltage as a function of junction temperature**
(V_{GE}=15V)

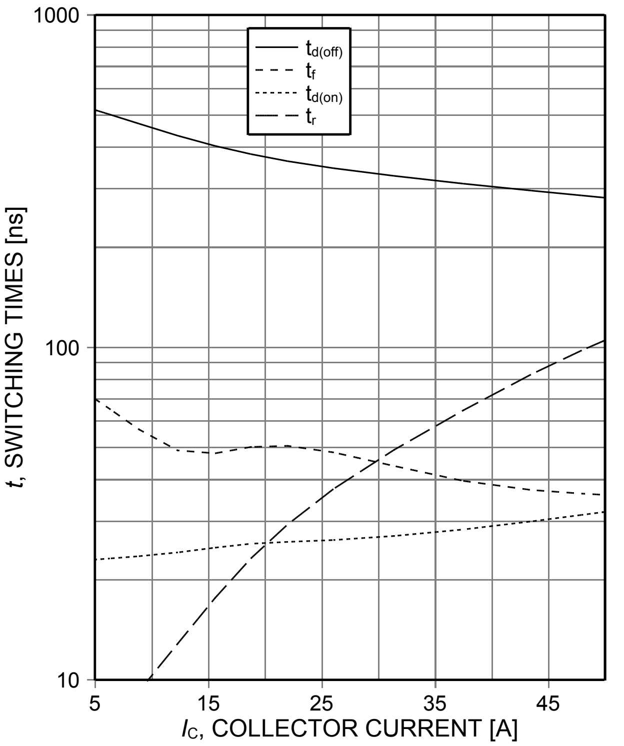


Figure 9. **Typical switching times as a function of collector current**
(ind. load, T_j=175°C, V_{CE}=600V, V_{GE}=15/0V, r_G=23Ω, test circuit in Fig. E)

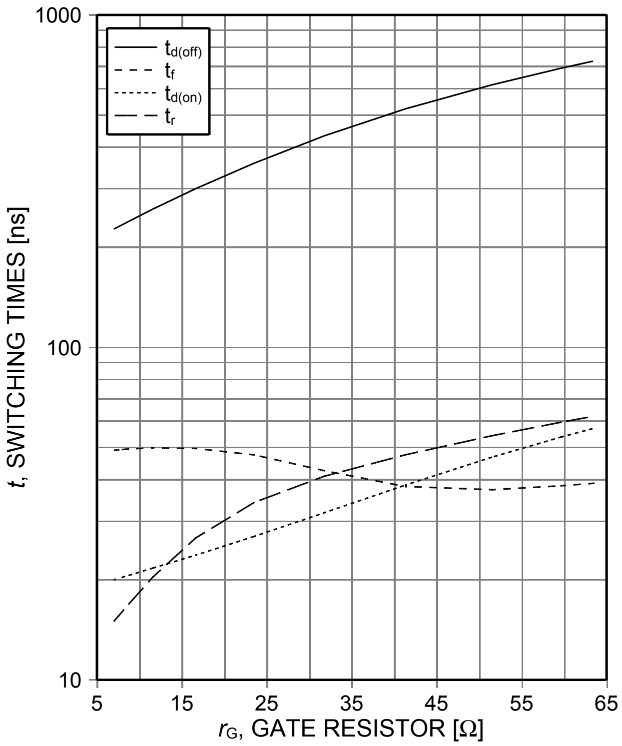


Figure 10. **Typical switching times as a function of gate resistor**
(ind. load, T_j=175°C, V_{CE}=600V, V_{GE}=15/0V, I_C=25A, test circuit in Fig. E)

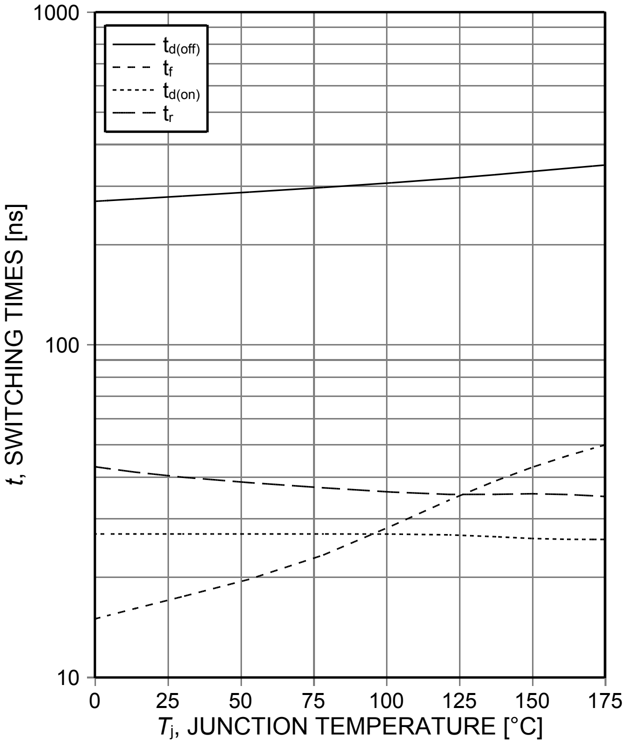


Figure 11. **Typical switching times as a function of junction temperature**
(ind. load, V_{CE}=600V, V_{GE}=15/0V, I_C=25A, r_G=23Ω, test circuit in Fig. E)

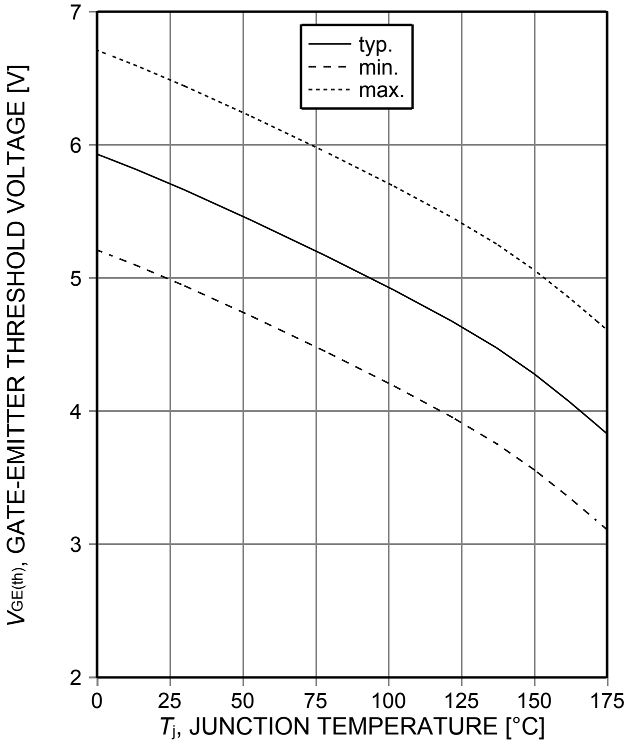


Figure 12. **Gate-emitter threshold voltage as a function of junction temperature**
(I_C=0.85mA)

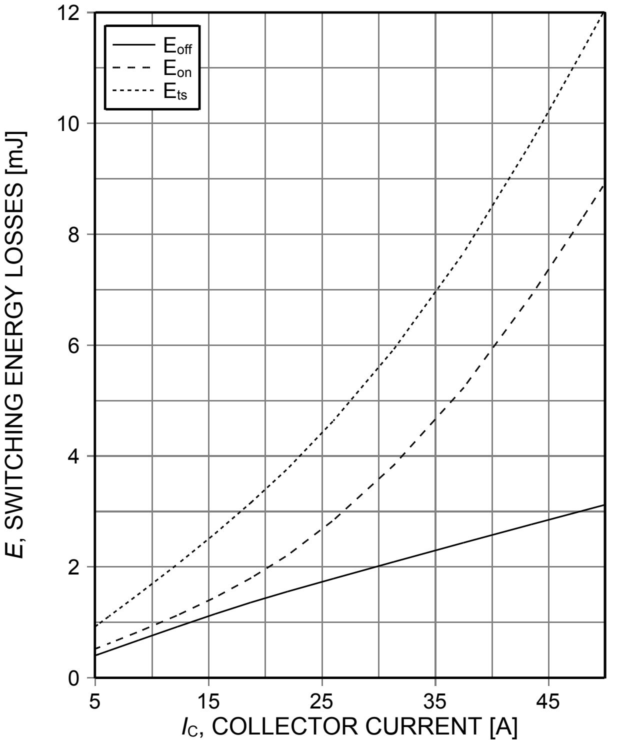


Figure 13. **Typical switching energy losses as a function of collector current**
(ind. load, T_j=175°C, V_{CE}=600V, V_{GE}=15/0V, r_G=23Ω, test circuit in Fig. E)

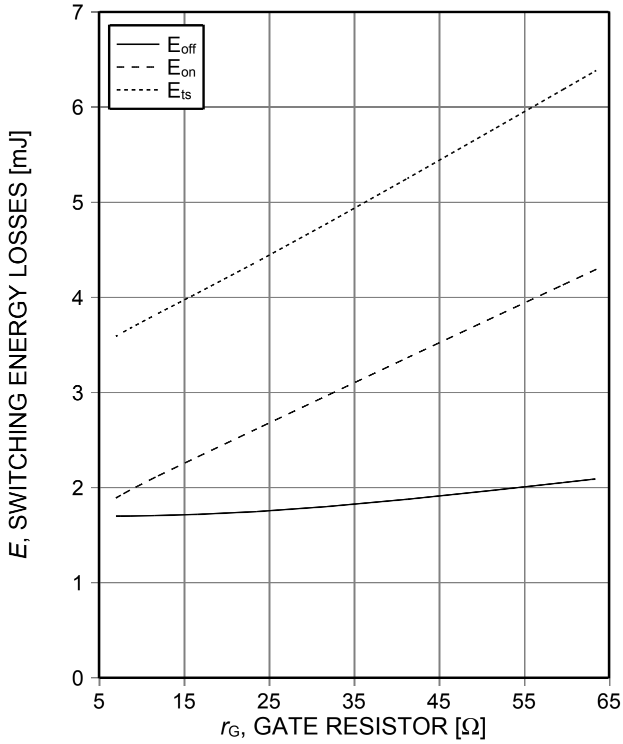


Figure 14. **Typical switching energy losses as a function of gate resistor**
(ind. load, T_j=175°C, V_{CE}=600V, V_{GE}=15/0V, I_C=25A, test circuit in Fig. E)

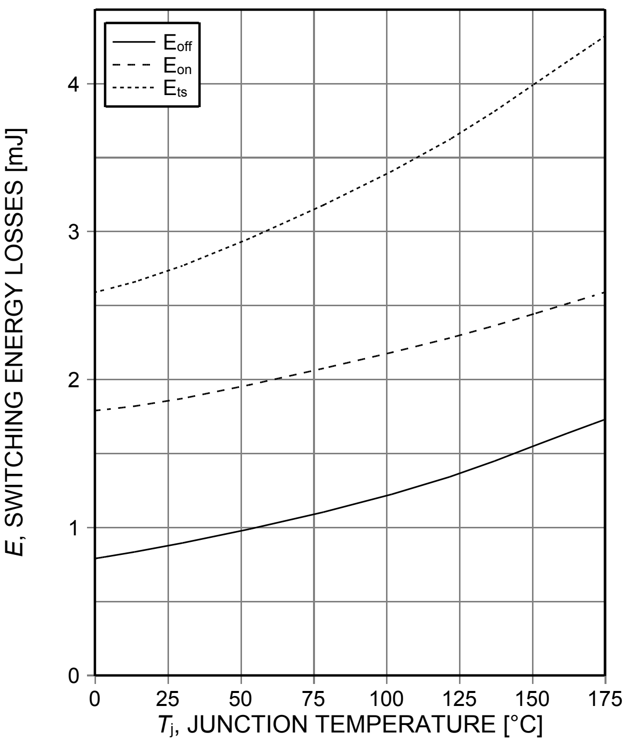


Figure 15. **Typical switching energy losses as a function of junction temperature**
(ind load, V_{CE}=600V, V_{GE}=15/0V, I_C=25A, r_G=23Ω, test circuit in Fig. E)

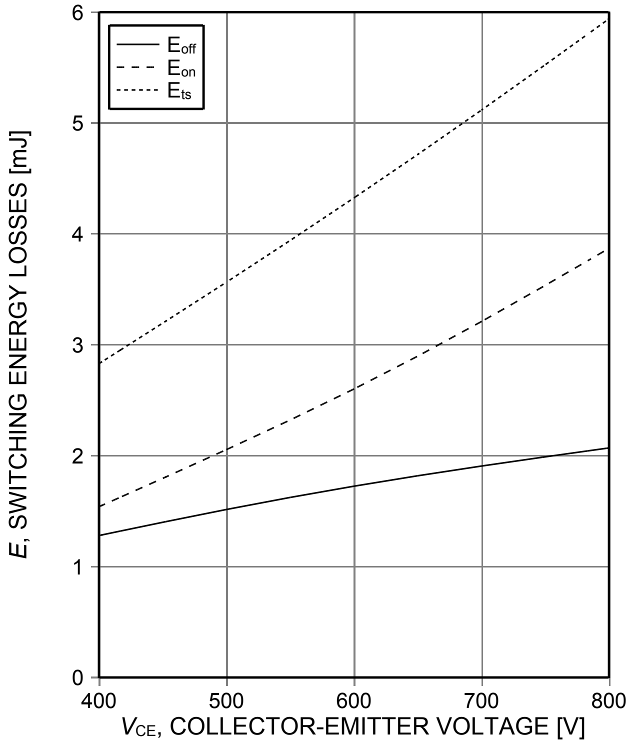


Figure 16. **Typical switching energy losses as a function of collector emitter voltage**
(ind. load, T_j=175°C, V_{GE}=15/0V, I_C=25A, r_G=23Ω, test circuit in Fig. E)

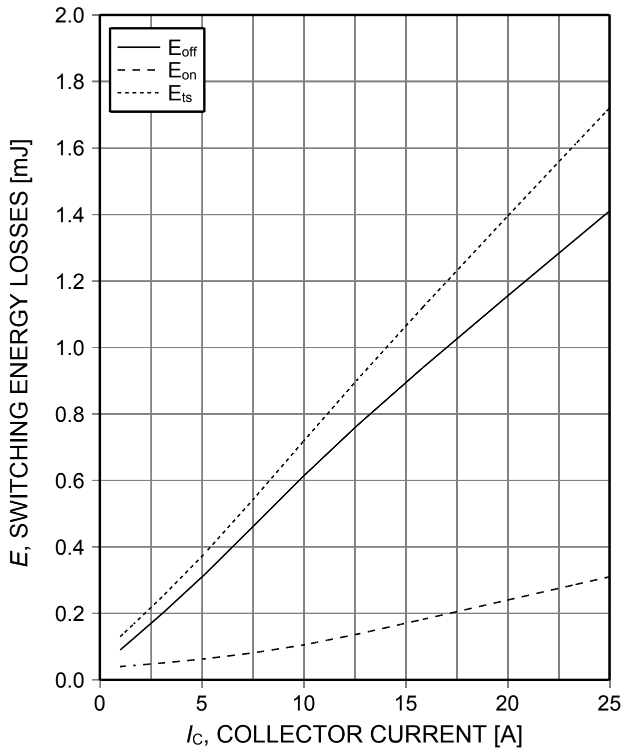


Figure 1. **Typical switching energy losses as a function of collector current**
(ind. load, T_j=125°C, V_{CE}=800V, V_{GE}=15/0V, r_G=3Ω, Diode IDH15S120)

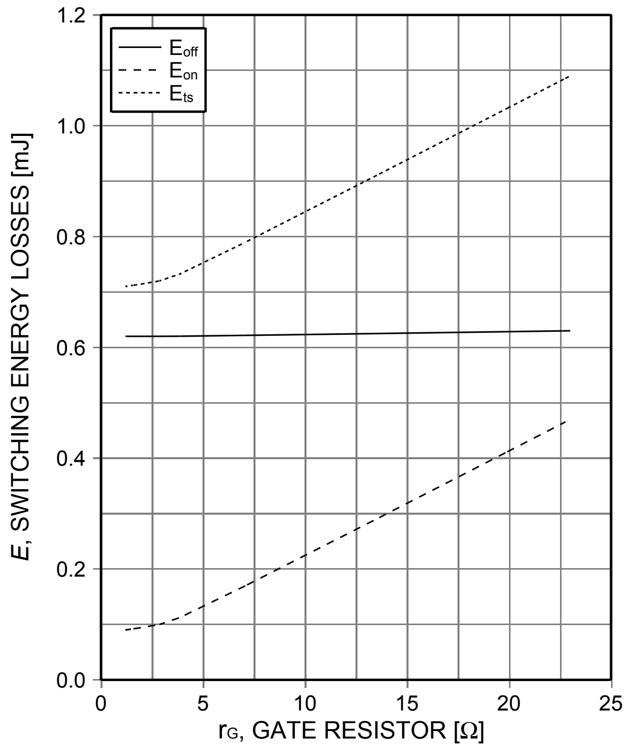


Figure 2. **Typical switching energy losses as a function of gate resistor**
(ind. load, T_j=125°C, V_{CE}=800V, V_{GE}=15/0V, I_C=10A, Diode IDH15S120)

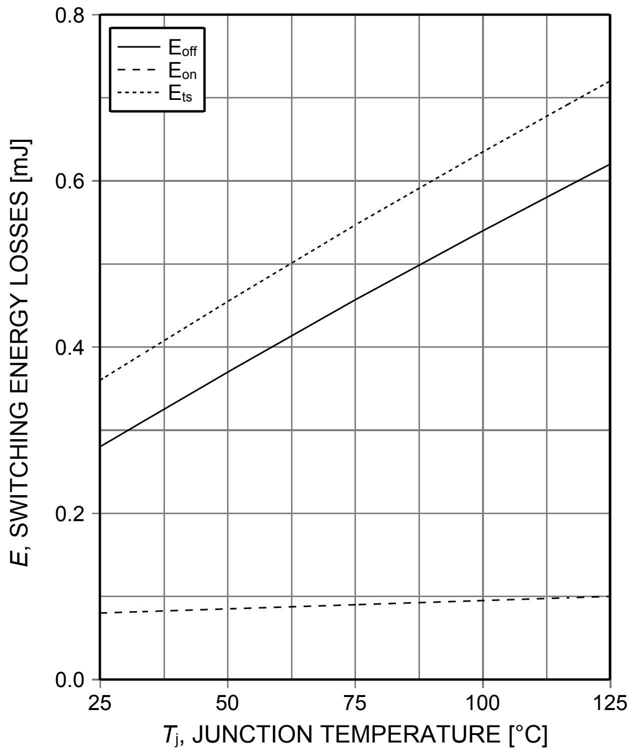


Figure 3. **Typical switching energy losses as a function of junction temperature**
(ind load, V_{CE}=800V, V_{GE}=15/0V, I_C=10A, r_G=3Ω, Diode IDH15S120)

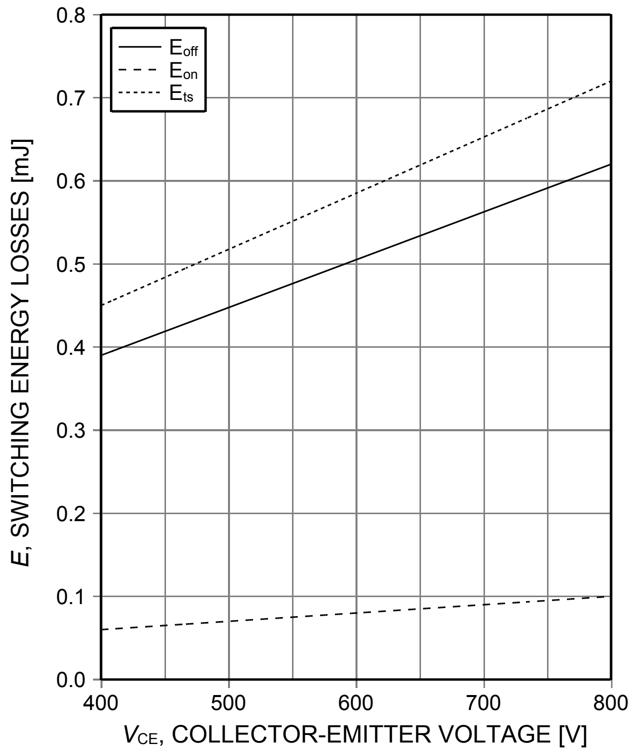


Figure 4. **Typical switching energy losses as a function of collector emitter voltage**
(ind. load, T_j=125°C, V_{GE}=15/0V, I_C=10A, r_G=3Ω, Diode IDH15S120)

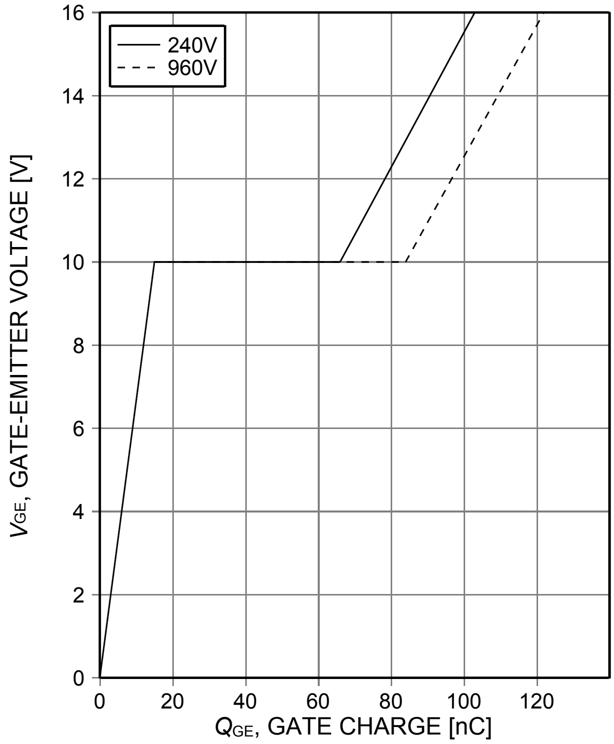


Figure 17. **Typical gate charge**
(I_C=25A)

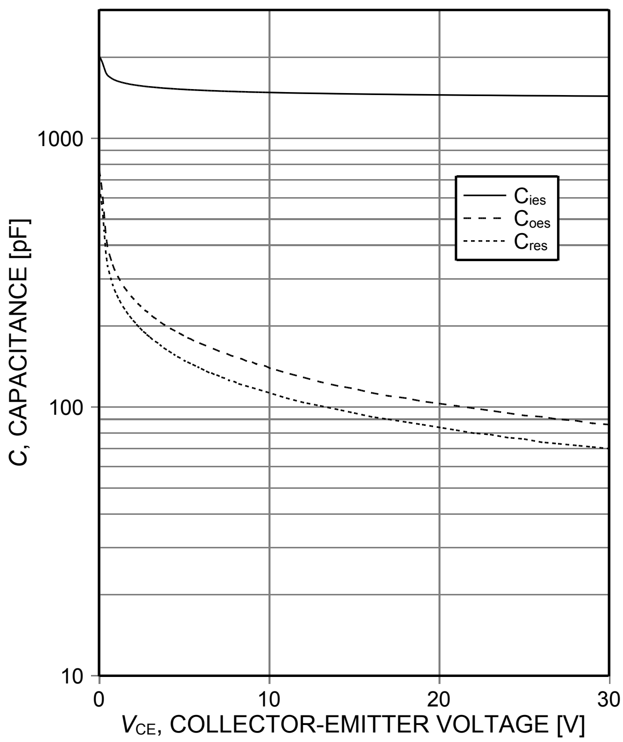


Figure 18. **Typical capacitance as a function of collector-emitter voltage**
(V_{GE}=0V, f=1MHz)

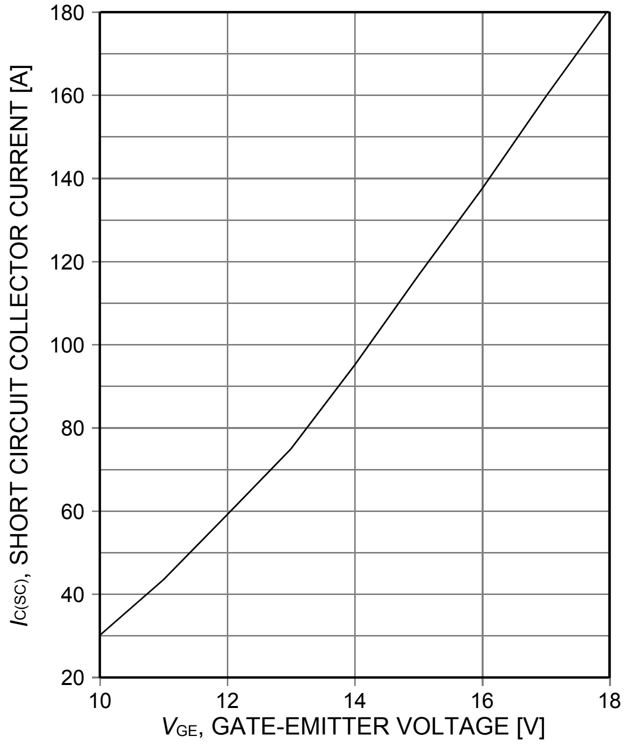


Figure 19. **Typical short circuit collector current as a function of gate-emitter voltage**
(V_{CE}≤600V, start at T_j=25°C)

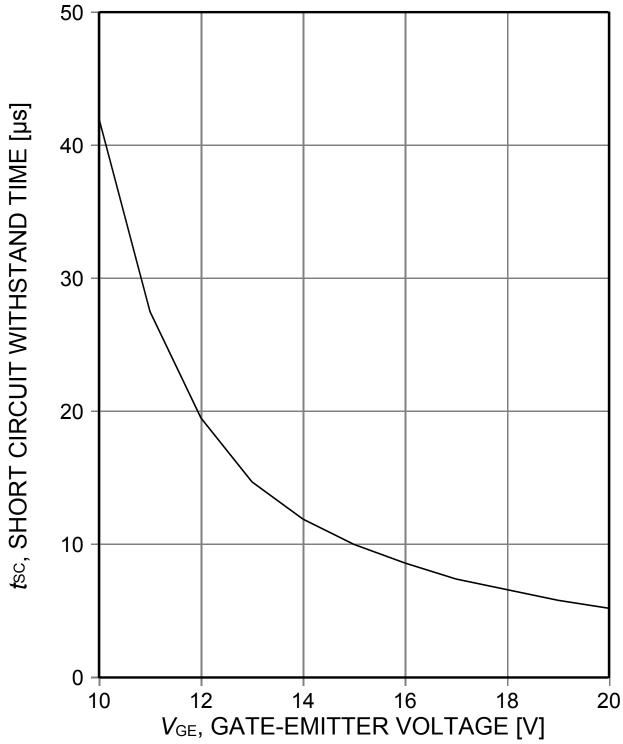


Figure 20. **Short circuit withstand time as a function of gate-emitter voltage**
(V_{CE}≤600V, start at T_j≤150°C)

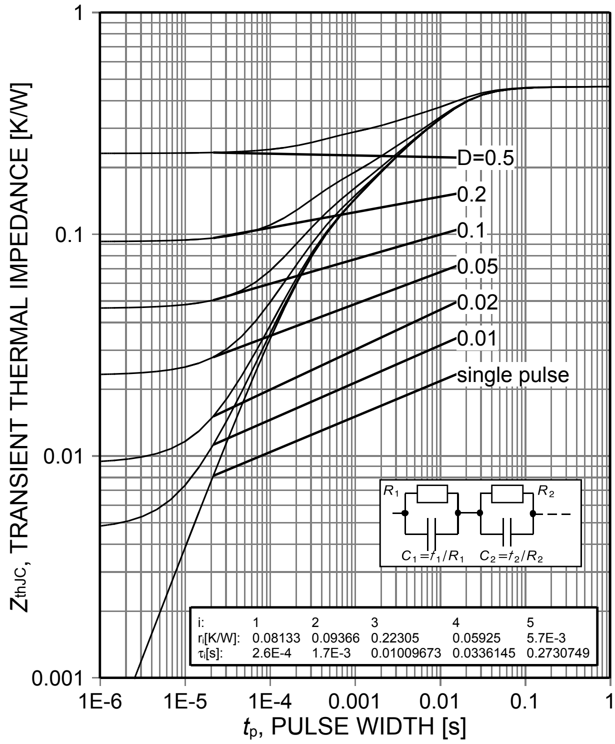
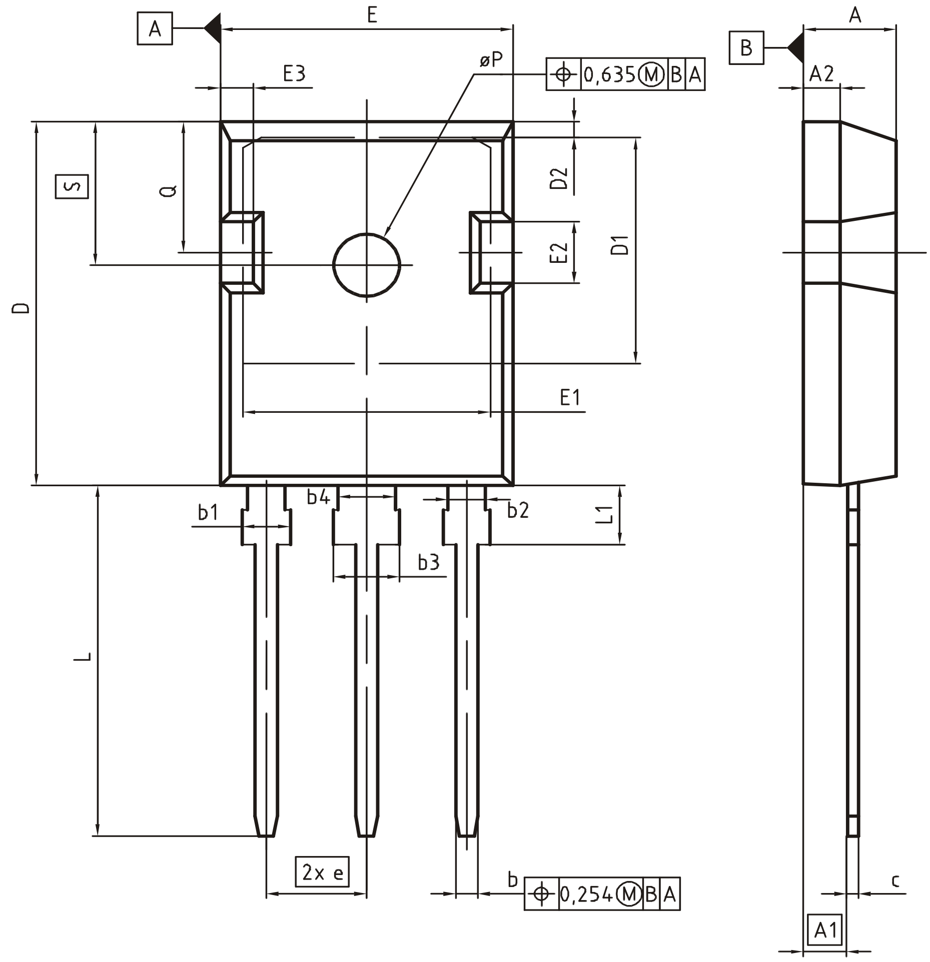


Figure 21. **IGBT transient thermal impedance**
($D=t_p/T$)

PG-TO247-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
øP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248

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SCALE 0 5 7.5mm

EUROPEAN PROJECTION

ISSUE DATE
09-07-2010

REVISION
05

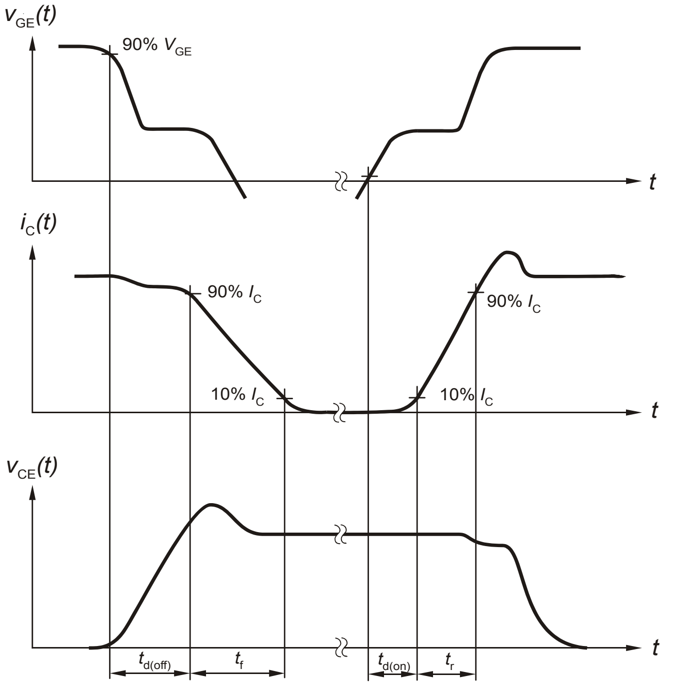

Figure A. Definition of switching times

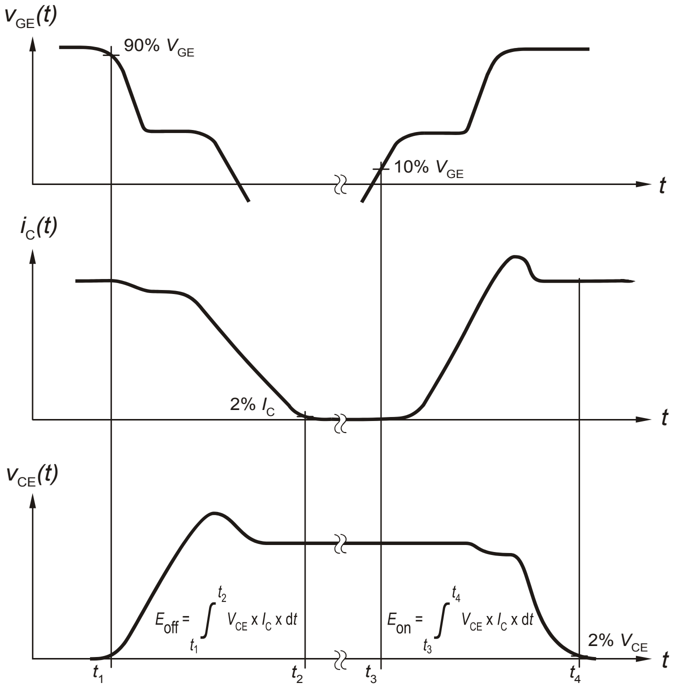

Figure B. Definition of switching losses

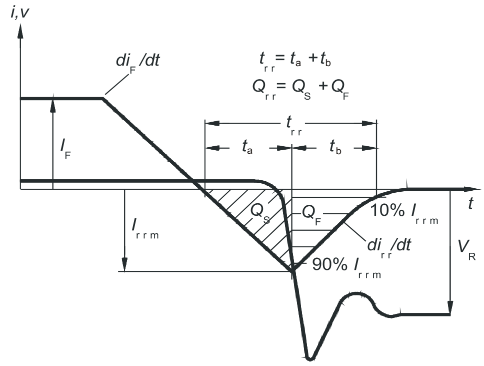

Figure C. Definition of diodes switching characteristics

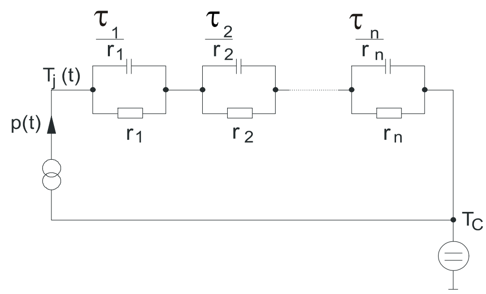

Figure D. Thermal equivalent circuit

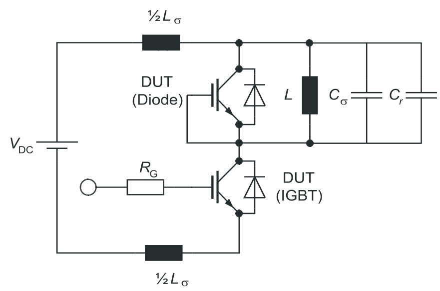

Figure E. Dynamic test circuit
Parasitic inductance L_σ,
Parasitic capacitor C_σ,
Relief capacitor C_r,
(only for ZVT switching)

Revision History

IGW25N120H3

Revision: 2014-02-27, Rev. 2.1

Previous Revision		
Revision	Date	Subjects (major changes since last revision)
1.1	2011-12-12	Preliminary data sheet
2.1	2014-02-27	Final data sheet

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Электрон
Связь

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